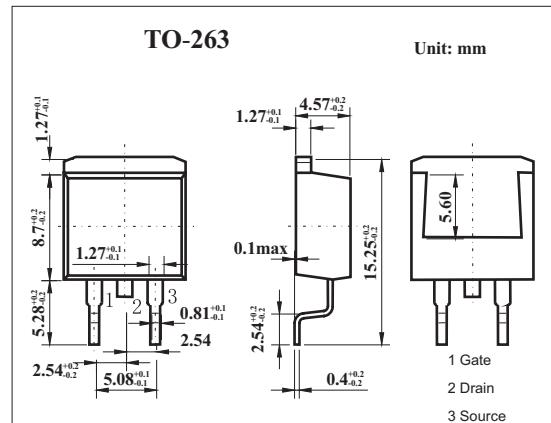


MOS Field Effect Transistor

2SK3900

■ Features

- Low On-state resistance
 $R_{DS(on)1} = 8.0\text{m}\Omega \text{ MAX. } (V_{GS} = 10 \text{ V}, I_D = 41\text{A})$
 $R_{DS(on)2} = 10 \text{ m}\Omega \text{ MAX. } (V_{GS} = 4.5 \text{ V}, I_D = 41 \text{ A})$
- Low C_{iss}: C_{iss} = 3500 pF TYP.



■ Absolute Maximum Ratings Ta = 25°C

Parameter	Symbol	Rating	Unit
Drain to source voltage	V _{DSS}	60	V
Gate to source voltage	V _{GSS}	±20	V
Drain current	I _D	±82	A
	I _{Dp} *	±246	A
Power dissipation TA=25°C TC=25°C	P _D	1.5	W
		104	
Channel temperature	T _{ch}	150	°C
Storage temperature	T _{stg}	-55 to +150	°C

* PW≤10 μ s,Duty Cycle≤1%

■ Electrical Characteristics Ta = 25°C

Parameter	Symbol	Testconditons	Min	Typ	Max	Unit
Drain cut-off current	I _{DSS}	V _{Ds} =60V,V _{GS} =0			10	μ A
Gate leakage current	I _{GSS}	V _{GS} =±20V,V _{Ds} =0			±10	μ A
Gate cut off voltage	V _{GS(off)}	V _{Ds} =10V,I _D =1mA	1.5	2.0	2.5	V
Forward transfer admittance	Y _{fs}	V _{Ds} =10V,I _D =41A	28.1	56		S
Drain to source on-state resistance	R _{DS(on)1}	V _{GS} =10V,I _D =41A		6.3	8.0	m Ω
	R _{DS(on)2}	V _{GS} =4.5V,I _D =41A		7.4	10	m Ω
Input capacitance	C _{iss}	V _{Ds} =10V,V _{GS} =0,f=1MHZ		3500		pF
Output capacitance	C _{oss}			660		pF
Reverse transfer capacitance	C _{rss}			240		pF
Turn-on delay time	t _{on}	I _D =41A,V _{GS(on)} =10V,R _G =0 Ω ,V _{DD} =30V		18		ns
Rise time	t _r			11		ns
Turn-off delay time	t _{off}			62		ns
Fall time	t _f			5.5		ns
Total Gate Charge	Q _G	V _{DD} = 48V V _{GS} = 10 V I _D = 82A		65.5		nC
Gate to Source Charge	Q _{GS}			11.5		nC
Gate to Drain Charge	Q _{GD}			16.5		nC